

# LTC1405

## ABSOLUTE MAXIMUM RATINGS

0V<sub>DD</sub> = V<sub>DD</sub> (Notes 1, 2)

Supply Voltage (V<sub>DD</sub>) ..... 6V

Negative Supply Voltage (V<sub>SS</sub>) ..... -6V

Total Supply Voltage (V<sub>DD</sub> to V<sub>SS</sub>) ..... 12V

Analog Input Voltage

(Note 3) ..... (V<sub>SS</sub> - 0.3V) to (V<sub>DD</sub> + 0.3V)

Digital Input Voltage

(Note 4) ..... (V<sub>SS</sub> - 0.3V) to (V<sub>DD</sub> + 0.3V)

Digital Output Voltage ..... (V<sub>SS</sub> - 0.3V) to (V<sub>DD</sub> + 0.3V)

Power Dissipation ..... 500mW

Operating Temperature Range

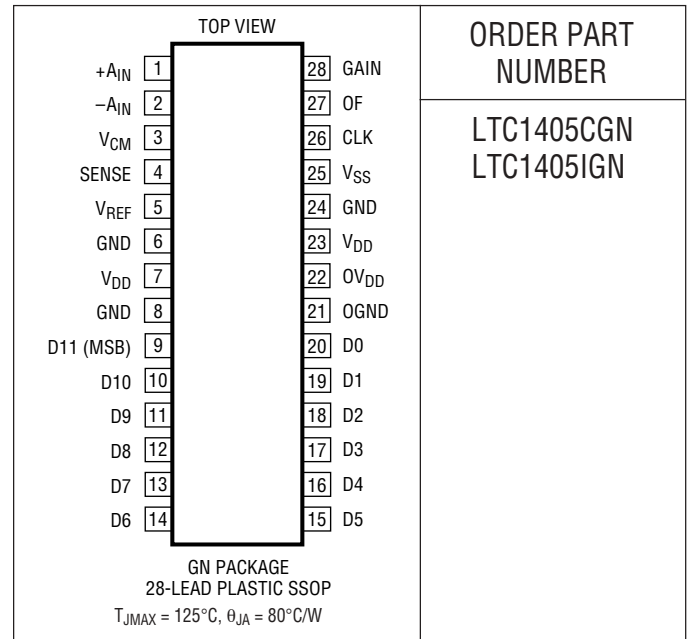
LTC1405C ..... 0°C to 70°C

LTC1405I ..... -40°C to 85°C

Storage Temperature Range ..... -65°C to 150°C

Lead Temperature (Soldering, 10 sec) ..... 300°C

## PACKAGE/ORDER INFORMATION



ORDER PART  
NUMBER

LTC1405CGN  
LTC1405IGN

Consult factory for parts specified with wider operating temperature ranges.

## CONVERTER CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C. With Internal 4.096V Reference. Specifications are guaranteed for both dual supply and single supply operation. (Note 5)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
Resolution (No Missing Codes)	●	12			Bits
Integral Linearity Error	(Note 7) ●		±0.35	±1	LSB
Differential Linearity Error	●		±0.25	±1	LSB
Offset Error	(Note 8) ●		±5	12 16	LSB LSB
Full-Scale Error			±10	30	LSB
Full-Scale Tempco	I <sub>OUT(REF)</sub> = 0		±15		ppm/°C

**ANALOG INPUT** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at T<sub>A</sub> = 25°C. Specifications are guaranteed for both dual supply and single supply operation. (Note 5)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
V <sub>IN</sub>	Analog Input Range (Note 9) +A <sub>IN</sub> - (-A <sub>IN</sub> )	V <sub>REF</sub> = 4.096V (SENSE = 0V), GAIN = 5V ● V <sub>REF</sub> = 4.096V (SENSE = 0V), GAIN = 0V ● V <sub>REF</sub> = 2.048V (SENSE = V <sub>REF</sub> ), GAIN = 5V ● V <sub>REF</sub> = 2.048V (SENSE = V <sub>REF</sub> ), GAIN = 0V ● External V <sub>REF</sub> (SENSE = 5V), GAIN = 5V ● External V <sub>REF</sub> (SENSE = 5V), GAIN = 0V ●		±2.048 ±1.024 ±1.024 ±0.512 ±V <sub>REF</sub> /2 ±V <sub>REF</sub> /4		V V V V V V
I <sub>IN</sub>	Analog Input Leakage Current	●			±10	μA
C <sub>IN</sub>	Analog Input Capacitance	Between Conversions During Conversions		12 6		pF pF
t <sub>ACQ</sub>	Sample-and-Hold Acquisition Time			50		ns

1405fa

**ANALOG INPUT** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . Specifications are guaranteed for both dual supply and single supply operation. (Note 5)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$t_{AP}$	Sample-and-Hold Aperture Delay Time			-250		ps
$t_{jitter}$	Sample-and-Hold Aperture Delay Time Jitter			0.6		ps
CMRR	Analog Input Common Mode Rejection Ratio	$-2.048\text{V} < (-A_{IN} = +A_{IN}) < 2.048\text{V}$		75		dB

**DYNAMIC ACCURACY** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ .  $V_{DD} = 5\text{V}$ ,  $V_{SS} = -5\text{V}$ ,  $f_{SAMPLE} = 5\text{MHz}$ ,  $V_{REF} = 4.096\text{V}$ .  $+A_{IN} = -0.1\text{dBFS}$  single ended input,  $-A_{IN} = 0\text{V}$ . (Note 6)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
S/(N + D)	Signal-to-Noise Plus Distortion Ratio	1MHz Input Signal	●	69.0	71.6	dB
		2.5MHz Input Signal	●	68.7	71.3	dB
THD	Total Harmonic Distortion	1MHz Input Signal, First 5 Harmonics	●	-87	-78.5	dB
		2.5MHz Input Signal, First 5 Harmonics	●	-83	-77.0	dB
SFDR	Peak Harmonic or Spurious Noise	1MHz Input Signal	●	-89	-79.5	dB
		2.5MHz Input Signal	●	-85	-78.0	dB
IMD	Intermodulation Distortion	$f_{IN1} = 29.37\text{kHz}$ , $f_{IN2} = 32.446\text{kHz}$		-80		dB
	Full-Power Bandwidth			100		MHz
	Input Referred Noise	$\pm 2.048\text{V}$ Input Range $\pm 1.024\text{V}$ Input Range, 2x Mode (SENSE = GAIN = 0V)		0.22 0.33		LSB <sub>RMS</sub> LSB <sub>RMS</sub>

## INTERNAL REFERENCE CHARACTERISTICS

$T_A = 25^\circ\text{C}$ . Specifications are guaranteed for both dual supply and single supply operation. (Note 5)

PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$V_{CM}$ Output Voltage	$I_{OUT} = 0$	2.475	2.500	2.525	V
$V_{CM}$ Output Tempco	$I_{OUT} = 0$		$\pm 15$		ppm/ $^\circ\text{C}$
$V_{CM}$ Line Regulation	$4.75\text{V} \leq V_{DD} \leq 5.25\text{V}$		0.6		mV/V
	$-5.25\text{V} \leq V_{SS} \leq -4.75\text{V}$		0.03		mV/V
$V_{CM}$ Output Resistance	$0.1\text{mA} \leq  I_{OUT}  \leq 0.1\text{mA}$		8		$\Omega$
$V_{REF}$ Output Voltage	SENSE = GND, $I_{OUT} = 0$		4.096		V
	SENSE = $V_{REF}$ , $I_{OUT} = 0$		2.048		V
	SENSE = $V_{DD}$		Drive $V_{REF}$ with External Reference		V
$V_{REF}$ Output Tempco			$\pm 15$		ppm/ $^\circ\text{C}$

**DIGITAL INPUTS AND OUTPUTS** The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . Specifications are guaranteed for both dual supply and single supply operation. (Note 5)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$V_{IH}$	High Level Input Voltage (Clock Pin)	$V_{DD} = 5.25\text{V}$ , $V_{SS} = 0\text{V}$	●	2.4		V
		$V_{DD} = 5.25\text{V}$ , $V_{SS} = -5\text{V}$	●	3.5		V
$V_{IL}$	Low Level Input Voltage (Clock Pin)	$V_{DD} = 4.75\text{V}$ , $V_{SS} = 0\text{V}$	●		0.8	V
		$V_{DD} = 4.75\text{V}$ , $V_{SS} = -5\text{V}$	●		1	V

## DIGITAL INPUTS AND OUTPUTS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . Specifications are guaranteed for both dual supply and single supply operation. (Note 5)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$I_{IN}$	Digital Input Current	$V_{IN} = 0\text{V to } V_{DD}$	●		$\pm 10$	$\mu\text{A}$
$C_{IN}$	Digital Input Capacitance			1.8		pF
$V_{OH}$	High Level Output Voltage	$0V_{DD} = 4.75\text{V}, I_O = -10\mu\text{A}$		4.74		V
		$0V_{DD} = 4.75\text{V}, I_O = -200\mu\text{A}$	●	4.0	4.71	V
		$0V_{DD} = 2.7\text{V}, I_O = -10\mu\text{A}$			2.6	V
		$0V_{DD} = 2.7\text{V}, I_O = -200\mu\text{A}$	●	2.3		V
$V_{OL}$	Low Level Output Voltage	$0V_{DD} = 4.75\text{V}, I_O = 160\mu\text{A}$		0.05		V
		$0V_{DD} = 4.75\text{V}, I_O = 1.6\text{mA}$	●	0.10	0.4	V
		$0V_{DD} = 2.7\text{V}, I_O = 160\mu\text{A}$		0.05		V
		$0V_{DD} = 2.7\text{V}, I_O = 1.6\text{mA}$	●	0.10	0.4	V
$I_{SOURCE}$	Output Source Current	$V_{OUT} = 0\text{V}$		50		mA
$I_{SINK}$	Output Sink Current	$V_{OUT} = V_{DD}$		35		mA

## POWER REQUIREMENTS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . Specifications are guaranteed for both dual supply and single supply operation. (Note 5)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$V_{DD}$	Positive Supply Voltage	(Note 10)	4.75		5.25	V
$V_{SS}$	Negative Supply Voltage	Dual Supply Mode	-5.25		-4.75	V
		Single Supply Mode		0		V
$I_{DD}$	Positive Supply Current	●		23	28	mA
$I_{SS}$	Negative Supply Current	●		0.8	1.2	mA
$P_D$	Power Dissipation	●		115	145	mW

## TIMING CHARACTERISTICS

The ● denotes the specifications which apply over the full operating temperature range, otherwise specifications are at  $T_A = 25^\circ\text{C}$ . Specifications are guaranteed for both dual supply and single supply operation. (Note 5)

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNITS
$f_{SAMPLE}$	Sampling Frequency	●	0.02		5	MHz
$t_{CONV}$	Conversion Time	●		150	180	ns
$t_{ACQ}$	Acquisition Time	●	20	50		ns
$t_H$	CLK High Time	(Note 9)	●	20	100	ns
$t_L$	CLK Low Time	(Note 9)	●	20	100	ns
$t_{AD}$	Aperture Delay of Sample-and-Hold			-250		ps

**Note 1:** Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

**Note 2:** All voltage values are with respect to ground with GND and OGND wired together (unless otherwise noted).

**Note 3:** When these pin voltages are taken below  $V_{SS}$  or above  $V_{DD}$ , they will be clamped by internal diodes. This product can handle input currents greater than 100mA below  $V_{SS}$  or above  $V_{DD}$  without latchup.

**Note 4:** When these pin voltages are taken below  $V_{SS}$  they will be clamped by internal diodes. This product can handle input currents greater than 100mA below  $V_{SS}$  without latchup. GAIN is not clamped to  $V_{DD}$ . When CLK is taken above  $V_{DD}$ , it will be clamped by an internal diode. The CLK pin can handle input currents of greater than 100mA above  $V_{DD}$  without latchup.

**Note 5:**  $V_{DD} = 5\text{V}$ ,  $V_{SS} = -5\text{V}$  or  $0\text{V}$ ,  $f_{SAMPLE} = 5\text{MHz}$ ,  $t_r = t_f = 5\text{ns}$  unless otherwise specified.

## ELECTRICAL CHARACTERISTICS

**Note 6:** Dynamic specifications are guaranteed for dual supply operation with a single-ended  $+A_{IN}$  input and  $-A_{IN}$  grounded. For single supply dynamic specifications, refer to the Typical Performance Characteristics.

**Note 7:** Integral nonlinearity is defined as the deviation of a code from a straight line passing through the actual endpoints of the transfer curve. The deviation is measured from the center of the quantization band.

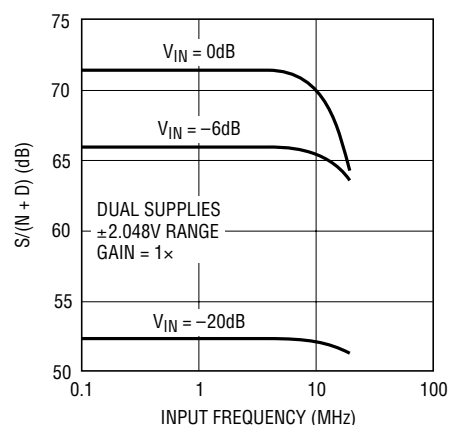
**Note 8:** Bipolar offset is the offset voltage measured from  $-0.5\text{LSB}$  when the output code flickers between 0000 0000 0000 and 1111 1111 1111.

**Note 9:** Guaranteed by design, not subject to test.

**Note 10:** Recommended operating conditions.

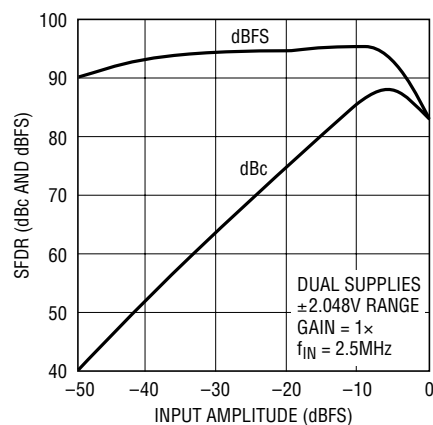
## TYPICAL PERFORMANCE CHARACTERISTICS

**S/(N+D) vs Input Frequency and Amplitude**



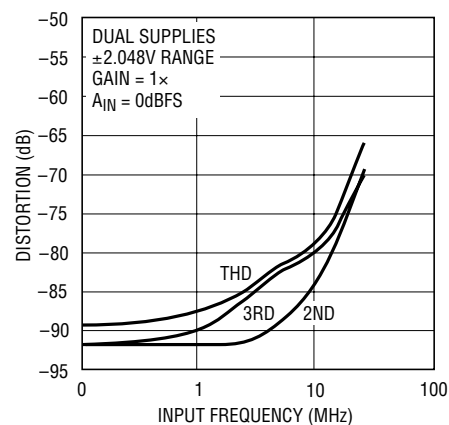
1405 G01

**Spurious-Free Dynamic Range vs Input Amplitude**



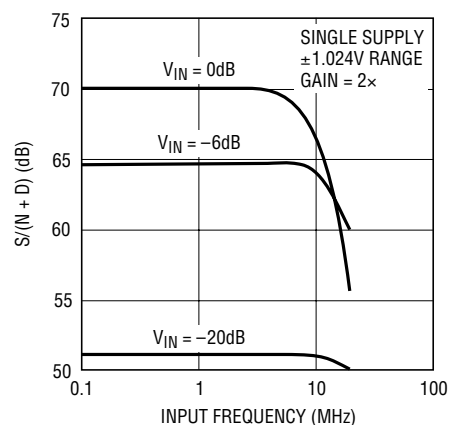
1405 G02

**Distortion vs Input Frequency**



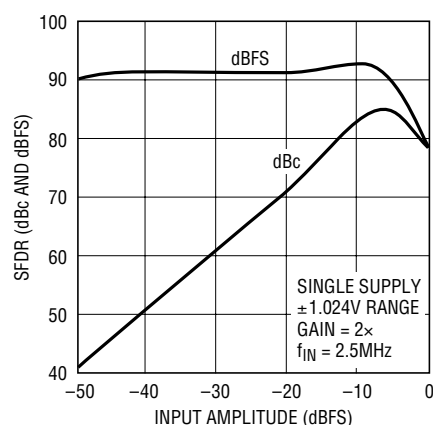
1405 G03

**S/(N+D) vs Input Frequency and Amplitude**



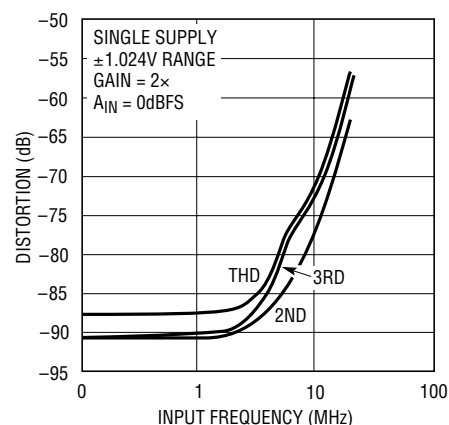
1405 G04

**Spurious-Free Dynamic Range vs Input Amplitude**



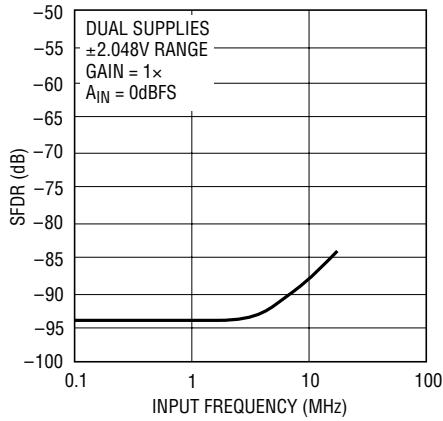
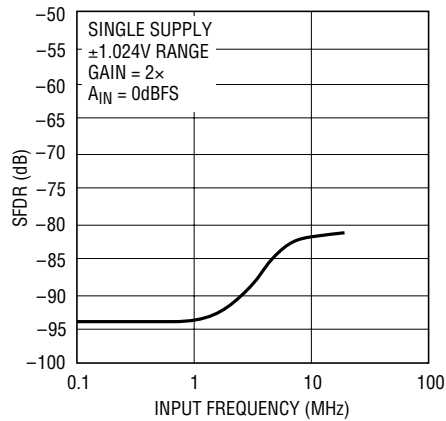
1405 G05

**Distortion vs Input Frequency**

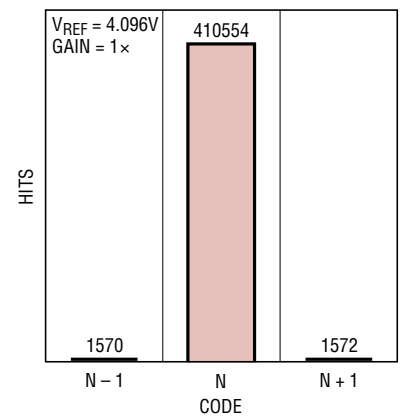
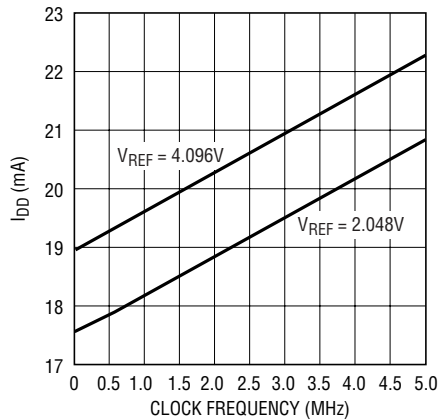
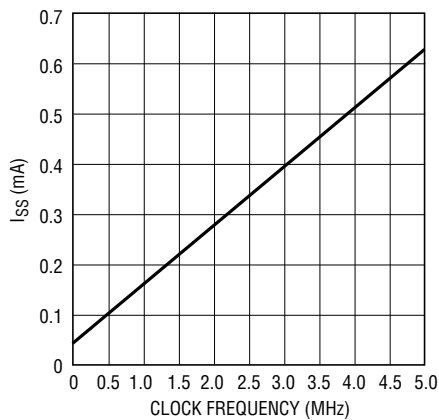


1405 G06

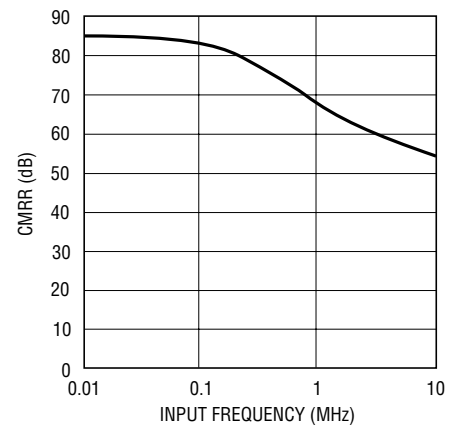
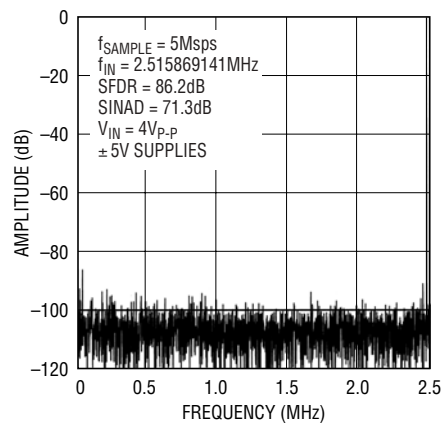
## TYPICAL PERFORMANCE CHARACTERISTICS

SFDR vs Input Frequency,  
Differential InputSFDR vs Input Frequency,  
Differential Input

Grounded Input Histogram

I<sub>DD</sub> vs Clock FrequencyI<sub>SS</sub> vs Clock Frequency

CMRR vs Input Frequency

LTC1405 Nonaveraged 4096  
Point FFT

## PIN FUNCTIONS

**+A<sub>IN</sub> (Pin 1):** Positive Analog Input.

**–A<sub>IN</sub> (Pin 2):** Negative Analog Input.

**V<sub>CM</sub> (Pin 3):** 2.5V Reference Output. Optional input common mode for single supply operation. Bypass to GND with a 1μF to 10μF ceramic.

**SENSE (Pin 4):** Reference Programming Pin. Ground selects V<sub>REF</sub> = 4.096V. Short to V<sub>REF</sub> for 2.048V. Connect SENSE to V<sub>DD</sub> to drive V<sub>REF</sub> with an external reference.

**V<sub>REF</sub> (Pin 5):** DAC Reference. Bypass to GND with a 1μF to 10μF ceramic.

**GND (Pin 6):** DAC Reference Ground.

**V<sub>DD</sub> (Pin 7):** Analog 5V Supply. Bypass to GND with a 1μF to 10μF ceramic.

**GND (Pin 8):** Analog Power Ground.

**D11 to D0 (Pins 9 to 20):** Data Outputs. The output format is two's complement.

**OGND (Pin 21):** Output Logic Ground. Tie to GND.

**OV<sub>DD</sub> (Pin 22):** Positive Supply for the Output Logic. Connect to Pin 23 for 5V logic. If not shorted to Pin 23, bypass to GND with a 1μF ceramic.

**V<sub>DD</sub> (Pin 23):** Analog 5V Supply. Bypass to GND with a 1μF ceramic.

**GND (Pin 24):** Analog Power Ground.

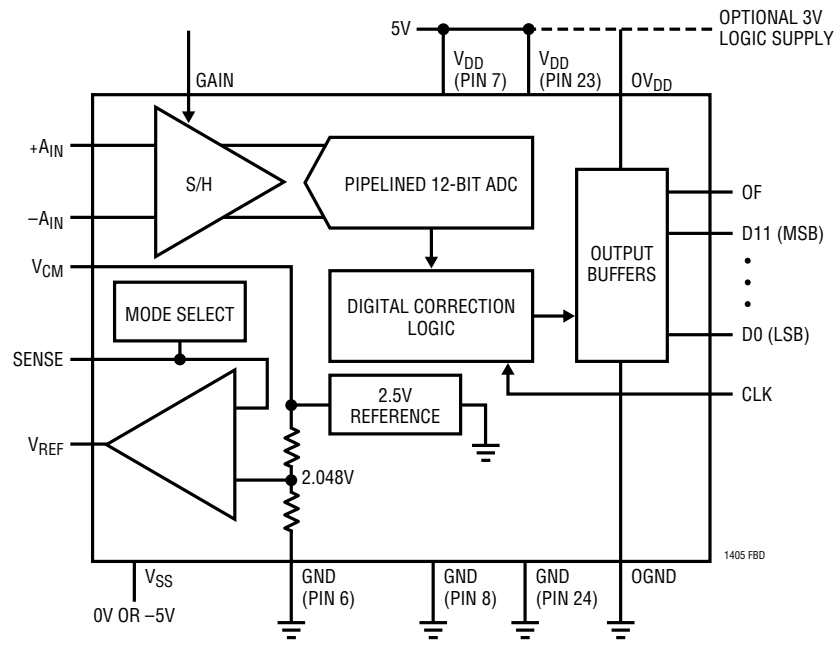
**V<sub>SS</sub> (Pin 25):** Negative Supply. Can be –5V or 0V. If V<sub>SS</sub> is not shorted to GND, bypass to GND with a 1μF ceramic.

**CLK (Pin 26):** Conversion Start Signal. This active high signal starts a conversion on its rising edge.

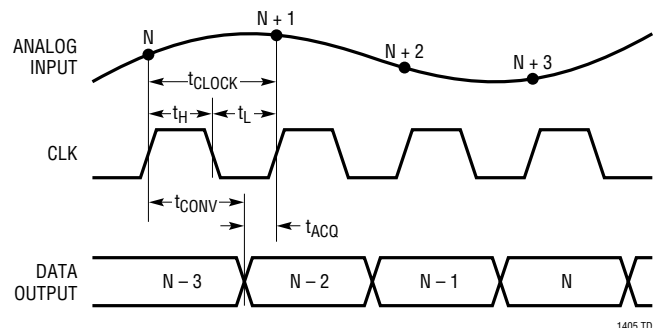
**OF (Pin 27):** Overflow Output. This signal is high when the digital output is 011111111111 or 100000000000.

**GAIN (Pin 28):** Gain Select for Input PGA. 5V selects an input gain of 1, 0V selects a gain of 2.

FUNCTIONAL BLOCK DIAGRAM



TIMING DIAGRAM



## APPLICATIONS INFORMATION

### Conversion Details

The LTC1405 is a high performance 12-bit A/D converter that operates up to 5Msps. It is a complete solution with an on-chip sample-and-hold, a 12-bit pipelined CMOS ADC, a low drift programmable reference and an input programmable gain amplifier. The digital output is parallel, with a 12-bit two's complement format and an out-of-range (overflow) bit.

The rising edge of the CLK begins the conversion. The differential analog inputs are simultaneously sampled and passed on to the pipelined A/D. After two more conversion starts (plus a 150ns conversion time) the digital outputs are updated with the conversion result and will be ready for capture on the third rising clock edge. Thus even though a new conversion is begun every time CLK goes high, each result takes three clock cycles to reach the output.

The analog signals that are passed from stage to stage in the pipelined A/D are stored on capacitors. The signals on these capacitors will be lost if the delay between conversions is too long. For accurate conversion results, the part should be clocked faster than 20kHz.

In some pipelined A/D converters if there is no clock present, dynamic logic on the chip will droop and the power consumption sharply increases. The LTC1405 doesn't have this problem. If the part is not clocked for 1ms, an internal timer will refresh the dynamic logic. Thus the clock can be turned off for long periods of time to save power.

### Power Supplies

The LTC1405 will operate from either a single 5V or dual  $\pm 5V$  supply, making it easy to interface the analog input to single or dual supply systems. The digital output drivers have their own power supply pin ( $0V_{DD}$ ) which can be set from 3V to 5V, allowing direct connection to either 3V or 5V digital systems. For single supply operation,  $V_{SS}$  should be connected to analog ground. For dual supply operation,  $V_{SS}$  should be connected to  $-5V$ . Both  $V_{DD}$  pins should be connected to a clean 5V analog supply. (Don't connect  $V_{DD}$  to a noisy system digital supply.)

### Analog Input Ranges

The LTC1405 has a flexible analog input with a wide selection of input ranges. The input range is always differential and is set by the voltages at the  $V_{REF}$  and the GAIN pins (Figure 1). The input range of the A/D core is fixed at  $\pm V_{REF}/2$ . The reference voltage,  $V_{REF}$ , is either set by the on-chip voltage reference or directly driven by an external voltage. The GAIN pin is a digital input that controls the gain of a preamplifier in the sample-and-hold circuit. The gain of this PGA can be set to 1x or 2x. Table 1 gives the input range in terms of  $V_{REF}$  and GAIN.

Table 1

GAIN PIN	PGA GAIN	INPUT RANGE ( $V_{IN} = A_{IN}^{+} - A_{IN}^{-}$ )
5V (Logic H)	1x	$-V_{REF}/2 < V_{IN} < V_{REF}/2$
0V (Logic L)	2x	$-V_{REF}/4 < V_{IN} < V_{REF}/4$

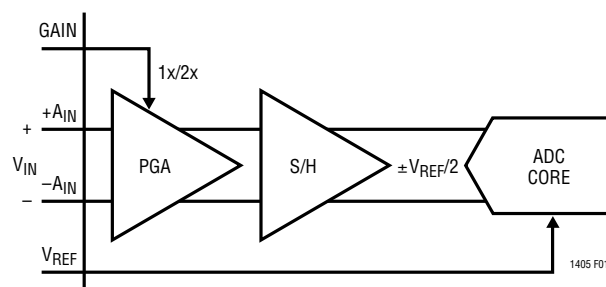


Figure 1. Analog Input Circuit

### Internal Reference

Figure 2 shows a simplified schematic of the LTC1405 reference circuitry. An on-chip temperature compensated bandgap reference ( $V_{CM}$ ) is factory trimmed to 2.500V. The voltage at the  $V_{REF}$  pin sets the input span of the ADC to  $\pm V_{REF}/2$ . An internal voltage divider converts  $V_{CM}$  to 2.048V, which is connected to a reference amplifier. The reference programming pin, SENSE, controls how the reference amplifier drives the  $V_{REF}$  pin. If SENSE is tied to ground, the reference amplifier feedback is connected to the R1/R2 voltage divider, thus making  $V_{REF} = 4.096V$ . If SENSE is tied to  $V_{REF}$ , the reference amplifier feedback is connected to SENSE thus making  $V_{REF} = 2.048V$ . If SENSE is tied to  $V_{DD}$ , the reference amplifier is disconnected from  $V_{REF}$  and  $V_{REF}$  can be driven by an external voltage. With two additional resistors,  $V_{REF}$  can be set to any voltage between 2.048V and 4.5V.



## APPLICATIONS INFORMATION

An external reference or a DAC can be used to drive  $V_{REF}$  over a 0V to 5V range (Figures 3a and 3b). The input impedance of the  $V_{REF}$  pin is  $2k\Omega$ , so a buffer may be required for high accuracy. Driving  $V_{REF}$  with a DAC is useful in applications where the peak input signal amplitude may vary. The input span of the ADC can then be adjusted to match the peak input signal, maximizing the signal-to-noise ratio.

Both the  $V_{CM}$  and  $V_{REF}$  pins must be bypassed with capacitors to ground. For best performance,  $1\mu F$  or larger ceramic capacitors are recommended. For the case of external circuitry driving  $V_{REF}$ , a smaller capacitor can be used at  $V_{REF}$  so the input range can be changed quickly. In this case, a  $0.05\mu F$  or larger ceramic capacitor is acceptable.

The  $V_{CM}$  pin is a low output impedance 2.5V reference that can be used by external circuitry. For single 5V supply applications it is convenient to connect  $A_{IN-}$  directly to the  $V_{CM}$  pin.

### Driving the Analog Inputs

The differential inputs of the LTC1405 are easy to drive. The inputs may be driven differentially or single-ended (i. e., the  $A_{IN-}$  input is held at a fixed value). The  $A_{IN-}$  and  $A_{IN+}$  inputs are simultaneously sampled and any common mode signal is reduced by the high common mode rejection of the sample-and-hold circuit. Any common mode input value is acceptable as long as the input pins stay between  $V_{DD}$  and  $V_{SS}$ . During conversion the analog inputs are high impedance. At the end of conversion the inputs draw a small current spike while charging the sample-and-hold.

For superior dynamic performance in dual supply mode, the LTC1405 should be operated with the analog inputs centered at ground, and in single supply mode the inputs should be centered at 2.5V. If required, the analog inputs can be driven differentially via a transformer. Refer to Table 2 for a summary of the analog input and reference configurations and their relative advantages.

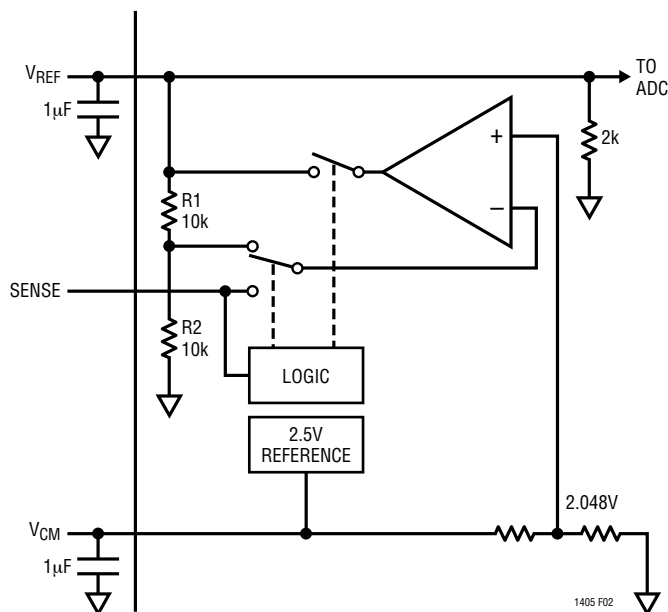


Figure 2. Reference Circuit

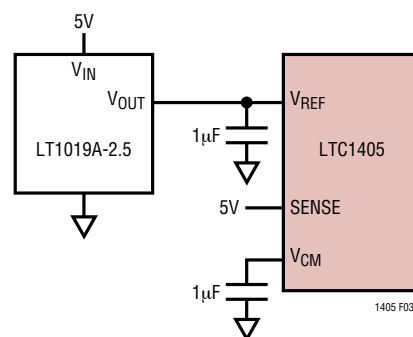


Figure 3a. Using the LT1019-2.5 As an External Reference; Input Range =  $\pm 1.25V$

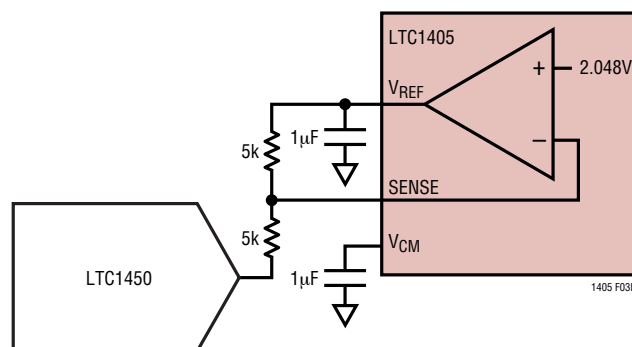


Figure 3b. Driving  $V_{REF}$  with a DAC

1405fa

## APPLICATIONS INFORMATION

Table 2. Comparison of Analog Input Configurations

SUPPLIES	COUPLING	V <sub>REF</sub>	GAIN	A <sub>IN</sub> <sup>+</sup>	A <sub>IN</sub> <sup>-</sup>	COMMENTS
±5V	DC	4.096V	1x	±2.048	0	Best SNR, THD
5V	DC	4.096V	2x	2.5 ± 1.024	2.5	Best SINAD, THD for Single Supply
5V	DC	2.048V	1x	2.5 ± 1.024	2.5	Worse Noise than Above Case
5V	DC	4.096V	1x	2.5 ± 2.048	2.5	Best Single Supply Noise, THD Is Not Optimal
5V	DC	4.096V	1x	0 to 4.096	2.048	Same As Above
±5V	AC (Transformer)	4.096V	1x	±1.024	±1.024	Very Best SNR, THD
5V	AC (Transformer)	4.096V	1x	2.5 ± 1.024	2.5 ± 1.024	Very Best SNR, THD for Single Supply

### DC Coupling the Input

In most applications the analog input signal can be directly coupled to the LTC1405 inputs. If the input signal is centered around ground, such as when dual supply op amps are used, simply connect A<sub>IN</sub><sup>-</sup> to ground and connect V<sub>SS</sub> to -5V (Figure 4). In a single power supply system with the input signal centered around 2.5V, connect A<sub>IN</sub><sup>-</sup> to V<sub>CM</sub> and V<sub>SS</sub> to ground (Figure 5). If the input signal is not centered around ground or 2.5V, the voltage for A<sub>IN</sub><sup>-</sup> must be generated externally by a resistor divider or a voltage reference (Figure 6).

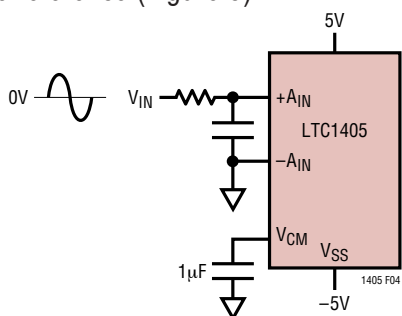


Figure 4. DC Coupling a Ground Centered Signal (Dual Supply System)

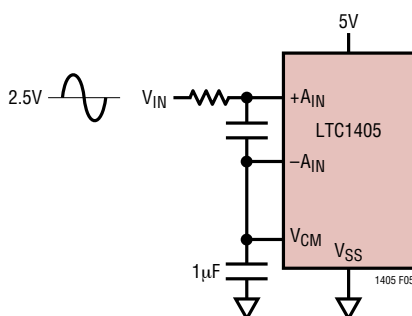


Figure 5. DC Coupling a Signal Centered Around 2.5V (Single Supply System)

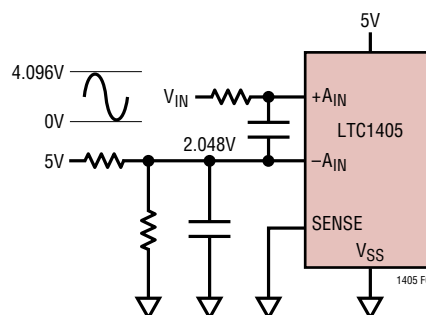


Figure 6. DC Coupling a 0V to 4.096V Signal

### AC Coupling the Input

The analog inputs to the LTC1405 can also be AC coupled through a capacitor, though in most cases it is simpler to directly couple the input to the ADC. Figure 7 shows an example where the input signal is centered around ground and the ADC operates from a single 5V supply. Note that the performance would improve if the ADC was operated from a dual supply and the input was directly coupled (as in Figure 4). With AC coupling the DC resistance to ground should be roughly matched for A<sub>IN</sub><sup>+</sup> and A<sub>IN</sub><sup>-</sup> to maintain offset accuracy.

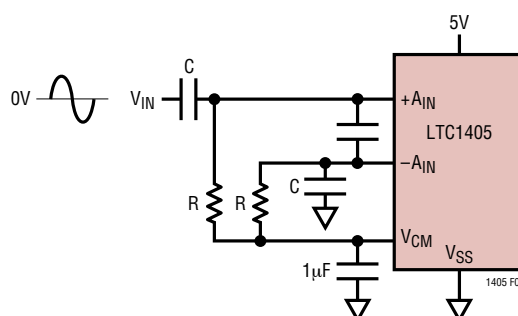


Figure 7. AC Coupling to the LTC1405. Note That the Input Signal Can Almost Always Be Directly Coupled with Better Performance

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## APPLICATIONS INFORMATION

### Differential Operation

The THD and SFDR performance of the LTC1405 can be improved by using a center tap RF transformer to drive the inputs differentially. Though the signal can no longer be DC coupled, the improvement in dynamic performance makes this an attractive solution for some applications. Typical connections for single and dual supply systems are shown in Figures 8a and 8b. Good choices for transformers are the Mini Circuits T1-1T (1:1 turns ratio) and T4-6T (1:4 turns ratio). For best results the transformer should be located close to the LTC1405 on the printed circuit board.

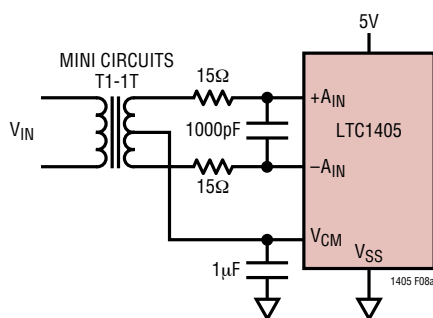


Figure 8a. Single Supply Transformer Coupled Input

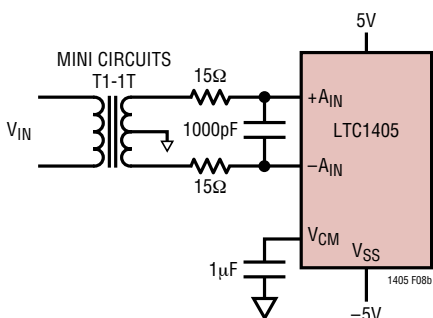


Figure 8b. Dual Supply Transformer Coupled Input

### Choosing an Input Amplifier

Choosing an input amplifier is easy if a few requirements are taken into consideration. First, to limit the magnitude of the voltage spike seen by the amplifier from charging the sampling capacitor, choose an amplifier that has a low output impedance ( $<100\Omega$ ) at the closed-loop bandwidth frequency. For example, if an amplifier is used in a gain of 1 and has a unity-gain bandwidth of 50MHz, then the output impedance at 50MHz must be less than  $100\Omega$ . The second requirement is that the closed-loop bandwidth

must be greater than 50MHz to ensure adequate small-signal settling for full throughput rate. If slower op amps are used, more settling time can be provided by increasing the time between conversions.

The best choice for an op amp to drive the LTC1405 will depend on the application. Generally applications fall into two categories: AC applications where dynamic specifications are most critical and time domain applications where DC accuracy and settling time are most critical.

### Input Filtering

The noise and the distortion of the input amplifier and other circuitry must be considered since they will add to the LTC1405 noise and distortion. The small-signal bandwidth of the sample-and-hold circuit is 100MHz. Any noise or distortion products that are present at the analog inputs will be summed over this entire bandwidth. Noisy input circuitry should be filtered prior to the analog inputs to minimize noise. A simple 1-pole RC filter is sufficient for many applications.

For example, Figure 9 shows a 1000pF capacitor from  $+A_{IN}$  to  $-A_{IN}$  and a  $30\Omega$  source resistor to limit the input bandwidth to 5.3MHz. The 1000pF capacitor also acts as a charge reservoir for the input sample-and-hold and isolates the amplifier driving  $V_{IN}$  from the ADC's small current glitch. In undersampling applications, an input capacitor this large may prohibitively limit the input bandwidth. If this is the case, use as large an input capacitance as possible. High quality capacitors and resistors should be used since these components can add distortion. NPO and silver mica type dielectric capacitors have excellent linearity. Carbon surface mount resistors can generate distortion from self-heating and from damage that may occur during soldering. Metal film surface mount resistors are much less susceptible to both problems.

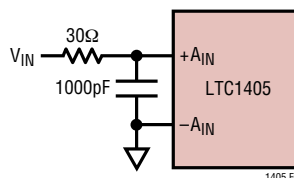


Figure 9. RC Input Filter

## APPLICATIONS INFORMATION

### Digital Outputs and Overflow Bit (OF)

Figure 10 shows the ideal input/output characteristics for the LTC1405. The output data is two's complement binary for all input ranges and for both single and dual supply operation. One LSB =  $V_{REF}/4.096$ . To create a straight binary output, invert the MSB (D11). The overflow bit (OF) indicates when the analog input is outside the input range of the converter. OF is high when the output code is 1000 0000 or 0111 1111 1111.

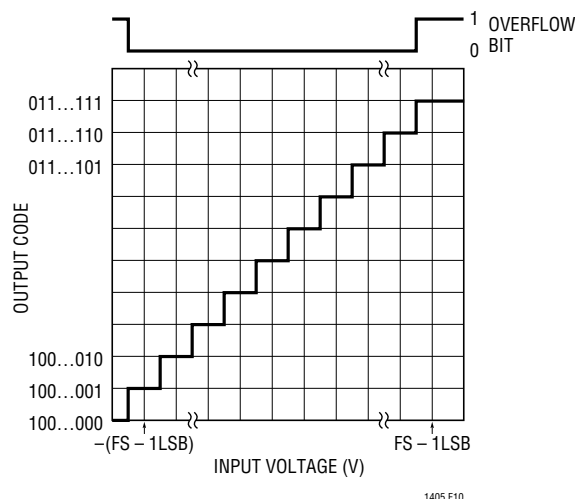


Figure 10. LTC1405 Transfer Characteristics

### Full-Scale and Offset Adjustment

In applications where absolute accuracy is important, offset and full-scale errors can be adjusted to zero. Offset error should be adjusted before full-scale error. Figure 11 shows a method for error adjustment for a dual supply, 4.096V application. For zero offset error apply  $-0.5\text{mV}$  (i. e.,  $-0.5\text{LSB}$ ) at  $+A_{IN}$  and adjust R1 until the output code flickers between 0000 0000 0000 and 1111 1111 1111. For full-scale adjustment, apply an input voltage of  $2.0465\text{V}$  ( $\text{FS} - 1.5\text{LSBs}$ ) at  $+A_{IN}$  and adjust R2 until the output code flickers between 0111 1111 1110 and 0111 1111 1111.

### Digital Output Drivers

The LTC1405 output drivers can interface to logic operating from 3V to 5V by setting  $\text{OV}_{DD}$  to the logic power supply. If 5V output is desired,  $\text{OV}_{DD}$  can be shorted to  $V_{DD}$  and share its decoupling capacitor. Otherwise,  $\text{OV}_{DD}$  requires its own  $1\mu\text{F}$  decoupling capacitor. To prevent digital

noise from affecting performance, the load capacitance on the digital outputs should be minimized. If large capacitive loads are required, ( $>30\text{pF}$ ) external buffers or  $100\Omega$  resistors in series with the digital outputs are suggested.

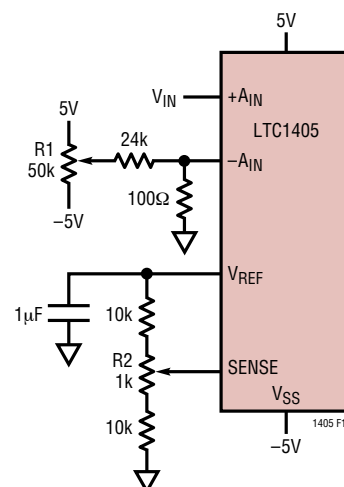


Figure 11. Offset and Full-Scale Adjust Circuit

### Timing

The conversion start is controlled by the rising edge of the CLK pin. Once a conversion is started it cannot be stopped or restarted until the conversion cycle is complete. Output data is updated at the end of conversion, or about 150ns after a conversion is begun. There is an additional two cycle pipeline delay, so the data for a given conversion is output two full clock cycles plus 150ns after the convert start. Thus output data can be latched on the third CLK rising edge after the rising edge that samples the input.

### Clock Input

The LTC1405 only uses the rising edge of the CLK pin for internal timing, and CLK doesn't necessarily need to have a 50% duty cycle. For optimal AC performance the rise time of the CLK should be less than 5ns. If the available clock has a rise time slower than 5ns, it can be locally sped up with a logic gate. With single supply operation the clock can be driven with 5V CMOS, 3V CMOS or TTL logic levels. With dual power supplies the clock should be driven with 5V CMOS levels.

As with all fast ADCs, the noise performance of the LTC1405 is sensitive to clock jitter when high speed inputs

## APPLICATIONS INFORMATION

are present. The SNR performance of an ADC when the performance is limited by jitter is given by:

$$\text{SNR} = -20 \log (2\pi f_{\text{IN}} t_J) \text{dB}$$

where  $f_{\text{IN}}$  is the frequency of an input sine wave and  $t_J$  is the root-mean-square jitter due to the clock, the analog input and the A/D aperture jitter. To minimize clock jitter, use a clean clock source such as a crystal oscillator, treat the clock signals as sensitive analog traces and use dedicated packages with good supply bypassing for any clock drivers.

### Board Layout

To obtain the best performance from the LTC1405, a printed circuit board with a ground plane is required. Layout for the printed circuit board should ensure that digital and analog signal lines are separated as much as possible. In particular, care should be taken not to run any digital track alongside an analog signal track.

An analog ground plane separate from the logic system ground should be placed under and around the ADC. Pins 6, 8 and 24 (GND), Pin 21 (OGND) and all other analog grounds should be connected to this ground plane. In single supply mode, Pin 25 ( $V_{\text{SS}}$ ) should also be

connected to this ground plane. All bypass capacitors for the LTC1405 should also be connected to this ground plane (Figure 12). The digital system ground should be connected to the analog ground plane at only one point, near the OGND pin.

The analog ground plane should be as close to the ADC as possible. Care should be taken to avoid making holes in the analog ground plane under and around the part. To accomplish this, we recommend placing vias for power and signal traces outside the area containing the part and the decoupling capacitors (Figure 13).

### Supply Bypassing

High quality, low series resistance ceramic  $1\mu\text{F}$  capacitors should be used at both  $V_{\text{DD}}$  pins,  $V_{\text{CM}}$  and  $V_{\text{REF}}$ . If  $V_{\text{SS}}$  is connected to  $-5\text{V}$  it should also be bypassed to ground with  $1\mu\text{F}$ . In single supply operation  $V_{\text{SS}}$  should be shorted to the ground plane as close to the part as possible. If  $\text{OV}_{\text{DD}}$  is not shorted to Pin 23 ( $V_{\text{DD}}$ ) it also requires a  $1\mu\text{F}$  decoupling capacitor to ground. Surface mount capacitors such as the AVX 0805ZC105KAT provide excellent bypassing in a small board space. The traces connecting the pins and the bypass capacitors must be kept short and should be made as wide as possible.

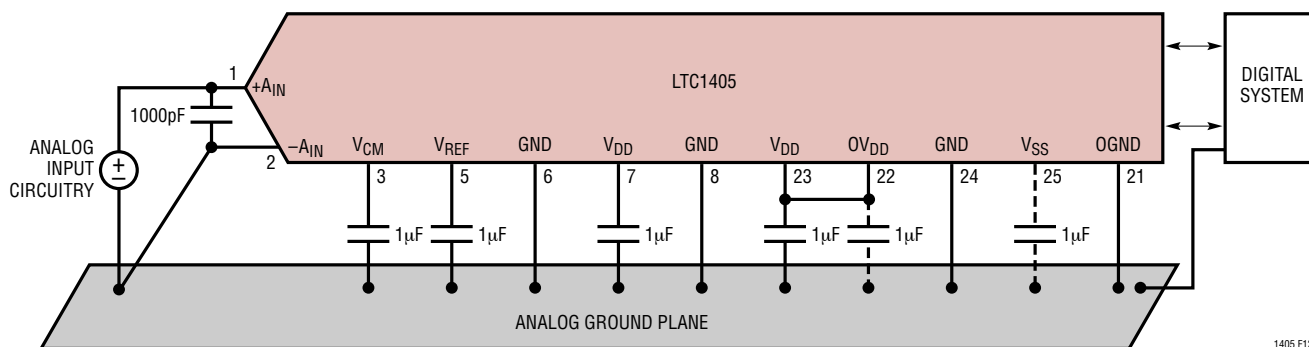


Figure 12. Power Supply Grounding

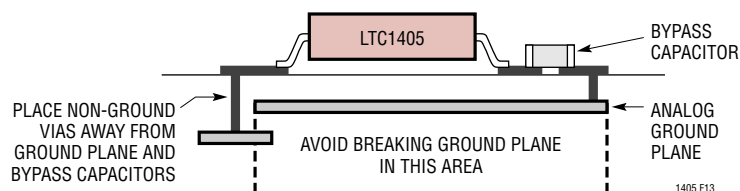


Figure 13. Cross Section of LTC1405 Printed Circuit Board

# APPLICATIONS INFORMATION

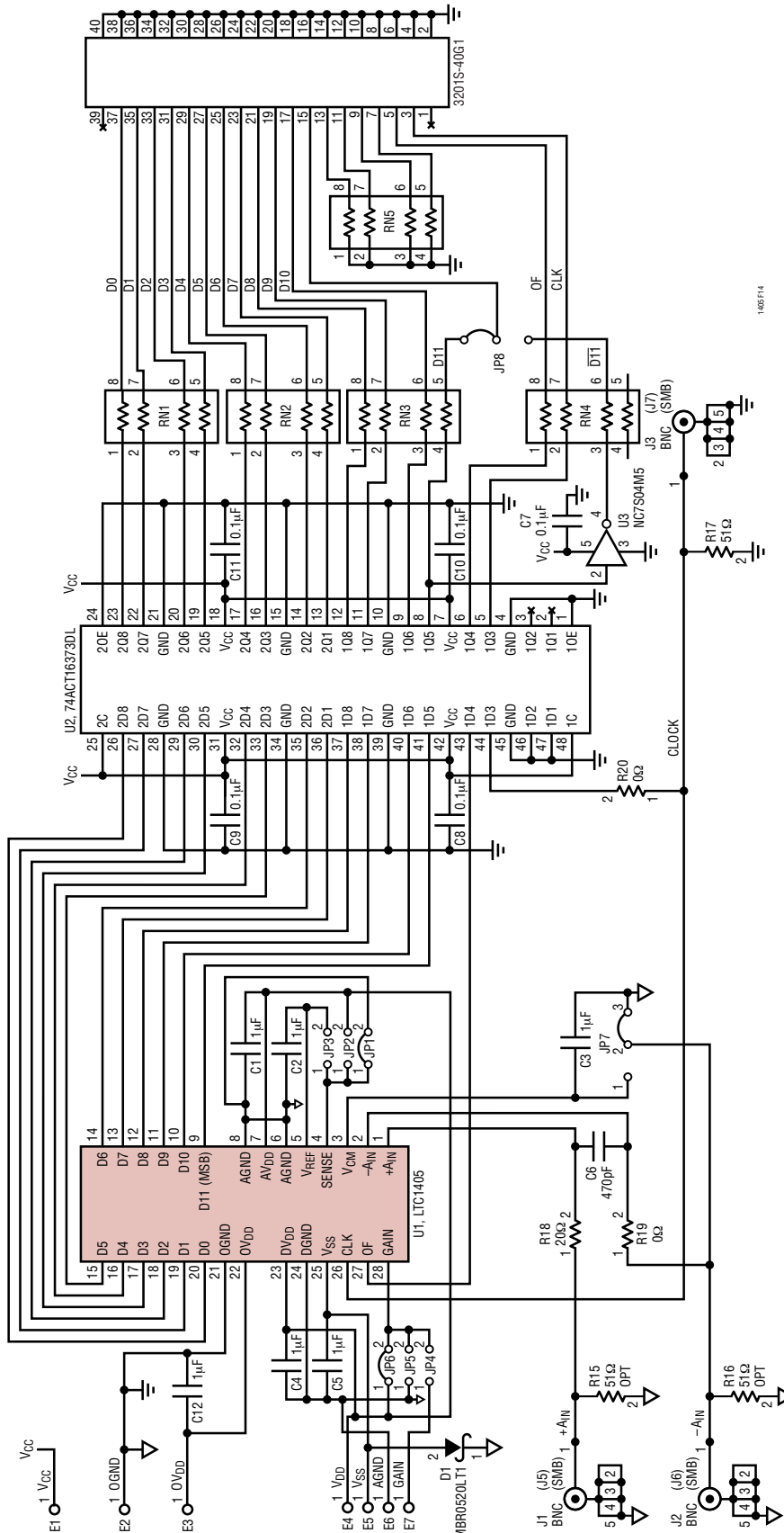


Figure 14. LTC1405 Demo Board Schematic

APPLICATIONS INFORMATION

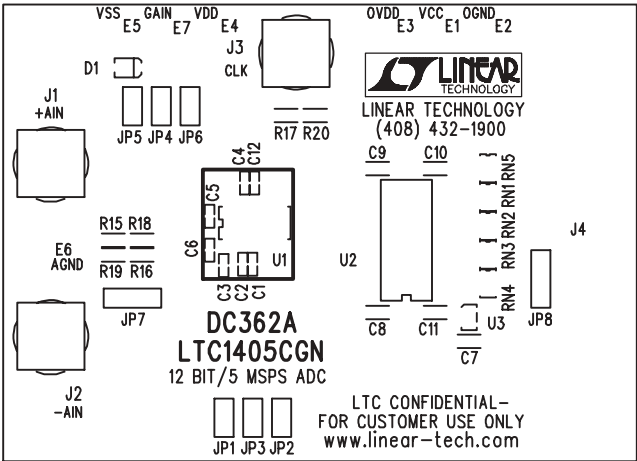


Figure 15. Top Silkscreen Layer for LTC1405/LTC1420 Demo Board

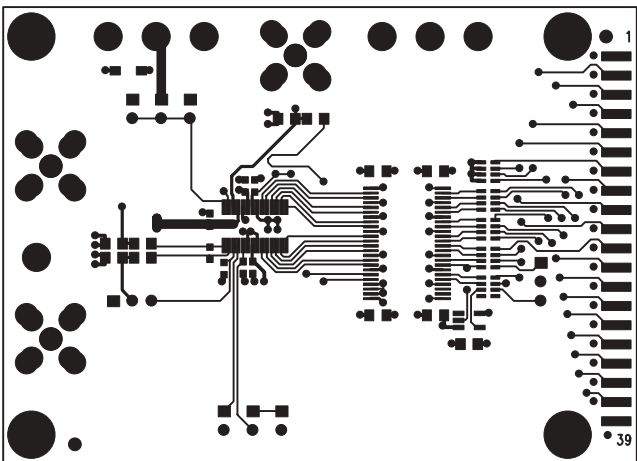


Figure 16. Top Layer for LTC1405/LTC1420 Demo Board

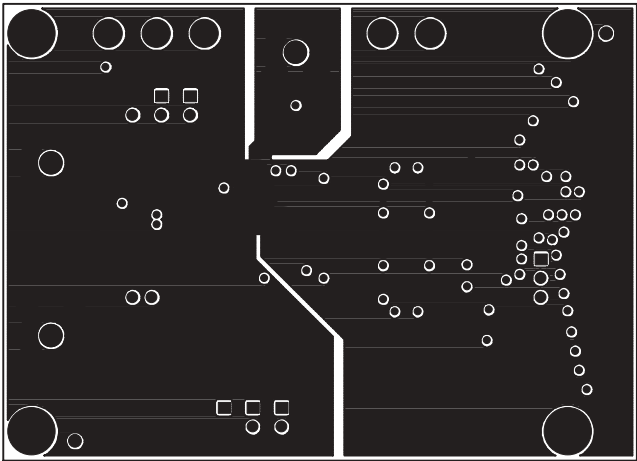


Figure 17. Ground Plane Layer for LTC1405/LTC1420 Demo Board

## APPLICATIONS INFORMATION

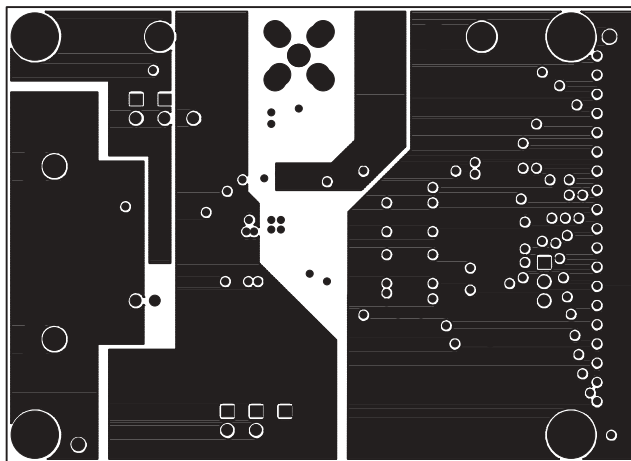


Figure 18. Power Plane Layer for LTC1405/LTC1420 Demo Board

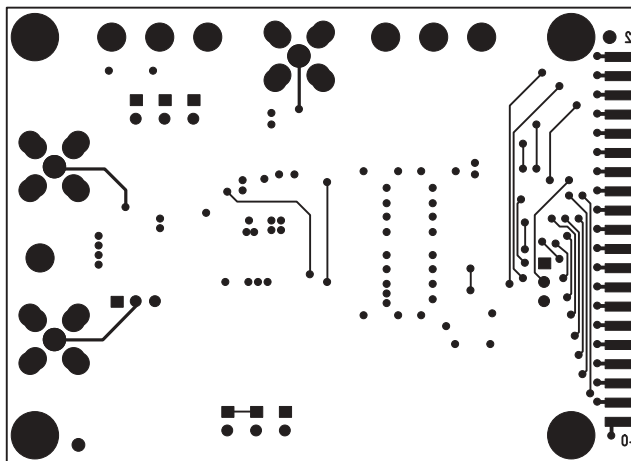
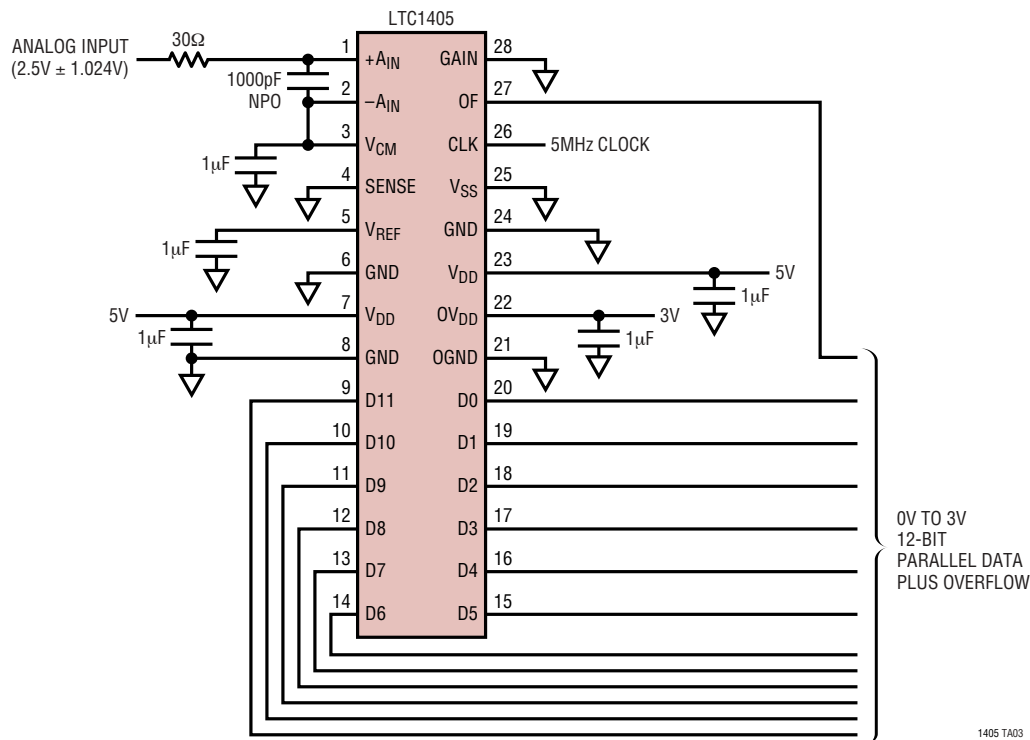


Figure 19. Bottom Layer for LTC1405/LTC1420 Demo Board

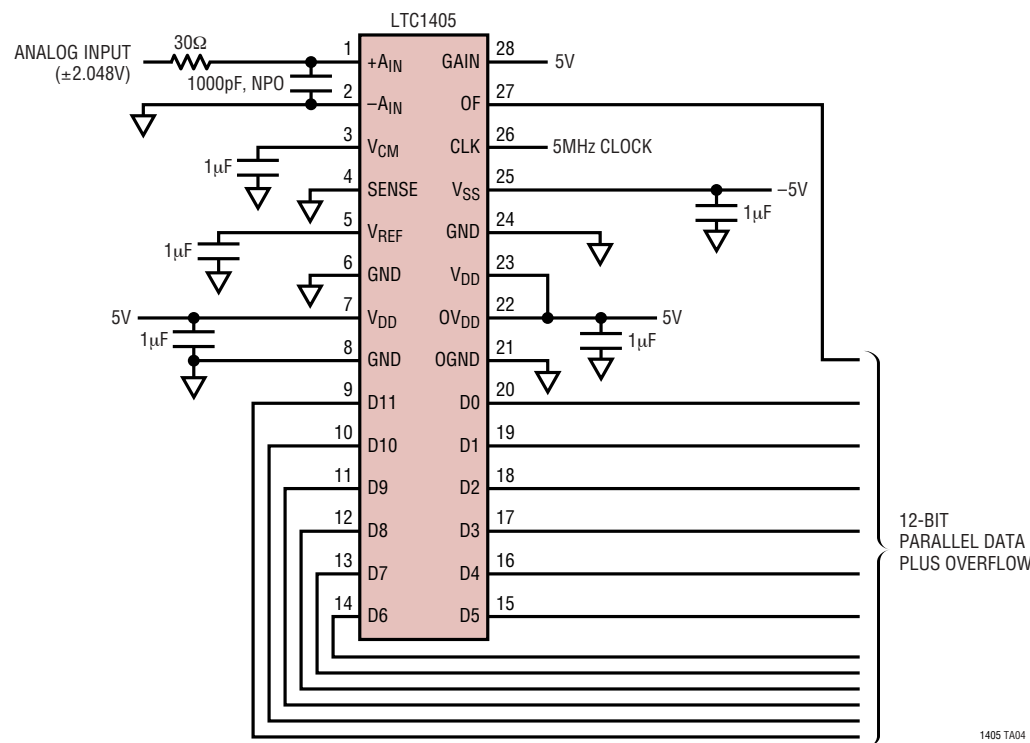


TYPICAL APPLICATION

Single Supply, 5Msps, 12-Bit ADC with 3V Logic Outputs

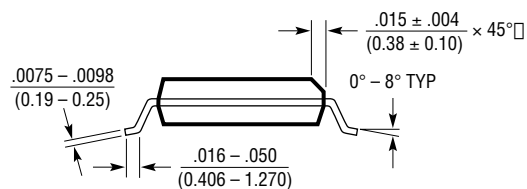
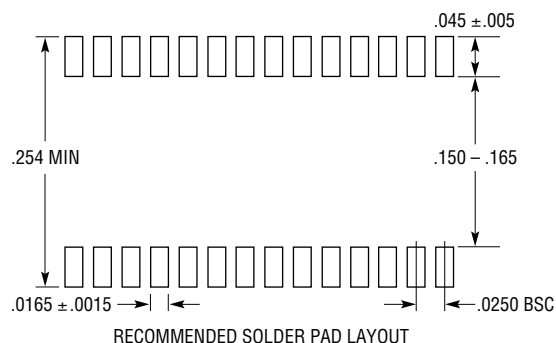


Dual Supply, 5Msps, 12-Bit ADC with 71.3dB SINAD



## PACKAGE DESCRIPTION

### GN Package 28-Lead Plastic SSOP (Narrow 0.150) (LTC DWG # 05-08-1641)

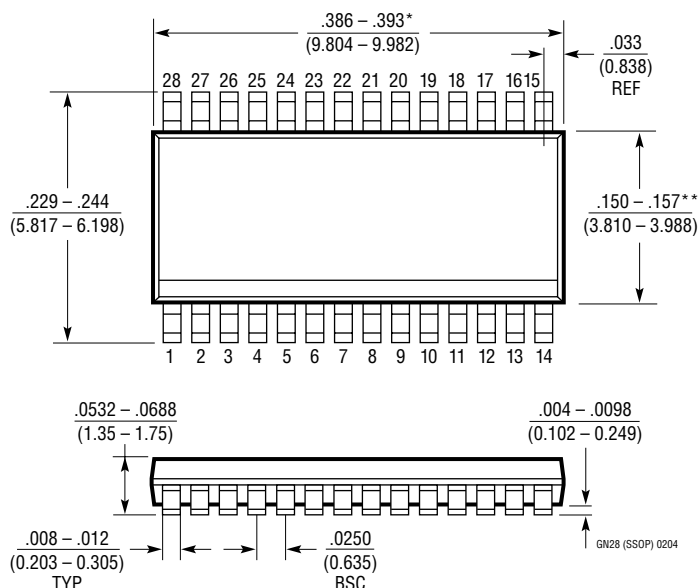


#### NOTE:

1. CONTROLLING DIMENSION: INCHES
2. DIMENSIONS ARE IN  $\frac{\text{INCHES}}{\text{MILLIMETERS}}$
3. DRAWING NOT TO SCALE

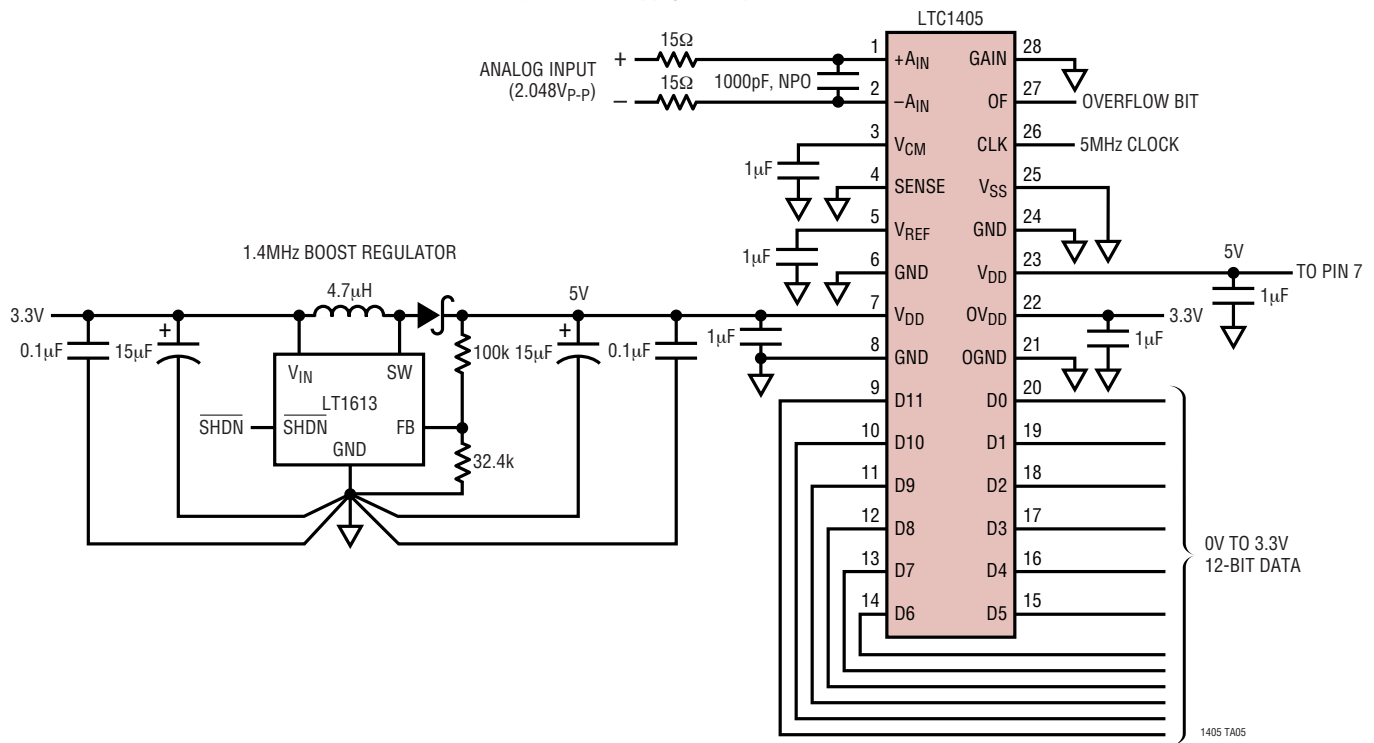
\*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

\*\*DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE



## TYPICAL APPLICATION

Single 3.3V Supply, 5Msps, 12-Bit ADC



## RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LT1019	Precision Bandgap Reference	0.05% Max Initial Accuracy, 5ppm/°C Max Drift
LTC1402	Serial 12-Bit, 2.2 Msps ADC	16-Pin Narrow SSOP Package, 72dB SINAD
LTC1403/LTC1403A	14-Bit/12-Bit, 2.8Msps Serial ADC	3V, 14mW, Differential Input, MSOP Package
LTC1407/LTC1407A	14-Bit/12-Bit, 3Msps Simultaneous Sampling Serial ADC	3V, 14mW, 2-Channel Differential Input, MSOP Package
LTC1412	12-Bit, 3Msps, Sampling ADC with Parallel Output	Best Dynamic Performance, SINAD = 72dB at Nyquist
LTC1415	Single 5V, 12-Bit, 1.25Msps with Parallel Output	55mW Power Dissipation, 72dB SINAD
LTC1420	12-Bit, 10Msps, Sampling ADC	Pin Compatible with LTC1405
LTC1668	16-Bit, 50Msps DAC	87dB SFDR, 1.5LSB DNL, Low Power
LTC2225	12-Bit, 10Msps ADC	60mW, 71dB SNR, 5mm x 5mm QFN
LTC2226	12-Bit, 25Msps ADC	75mW, 71dB SNR, 5mm x 5mm QFN
LTC2227	12-Bit, 40Msps ADC	125mW, 71dB SNR, 5mm x 5mm QFN
LTC2228	12-Bit, 65Msps ADC	210mW, 71dB SNR, 5mm x 5mm QFN
LTC2236	10-Bit, 25Msps ADC	75mW, 61dB SNR, 5mm x 5mm QFN
LTC2237	10-Bit, 40Msps ADC	125mW, 61dB SNR, 5mm x 5mm QFN
LTC2238	10-Bit, 65Msps ADC	210mW, 61dB SNR, 5mm x 5mm QFN
LTC2245	14-Bit, 10Msps ADC	60mW, 74.4dB SNR, 5mm x 5mm QFN
LTC2246	14-Bit, 25Msps ADC	75mW, 74dB SNR, 5mm x 5mm QFN
LTC2247	14-Bit, 40Msps ADC	125mW, 74dB SNR, 5mm x 5mm QFN
LTC2248	14-Bit, 65Msps ADC	210mW, 74dB SNR, 5mm x 5mm QFN

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